IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information			
Supplie	r Information														
Company name* Company unique II				ique ID	e ID Unique I		Unique ID Au	nique ID Authority			Respon	Response Date*			
onsemi											2024-05	2024-05-02			
Contact Name Tit				Title - Contact			Phone - Contact*				Email -	Email - Contact*			
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorize	ed Representative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da	Date Version Manufacturing Site			Weight*	UOM	Unit Type		
		NCV7344AD10R2G HS LP CANFD (V		HS LP CANFD (W	'U-SFT)		2024-05-02 PHG		PHG		81.78	mg	Each		
Aanufa	ecturing Process Inform	nation						·						,	
	Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material			erminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temper		ody Temperatu	ature Max Time at Peak Temper		ture Nu	mber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy			2			260		C	30	seco	nds 3				
Comments															
TTENT	ION: MSL 2 Rated item requi	res Dry Pack (a	ıfter electrical	test)											
or more	information regarding materi	al composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the					
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.89	mg	Supplier	Silicon (Si)	7440-21-3		3.89	mg
Die Attach	1.25	mg		Epoxy resin	proprietary data		0.125	mg
			Supplier	Silver (Ag)	7440-22-4		1	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.125	mg
Lead Frame	28.82	mg	Supplier	Zinc (Zn)	7440-66-6		0.0288	mg
			Supplier	Iron (Fe)	7439-89-6		0.6629	mg
			Supplier	Copper (Cu)	7440-50-8		28.0995	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0288	mg
Lead Frame plating	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.3	mg
Mold Compound-Black	46.29	mg		Epoxy resin	proprietary data		3.4718	mg
			Supplier	Phenolic Resin	Proprietary Data		1.1573	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.4718	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2315	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		37.9578	mg
Plating	0.96	mg	Supplier	Tin (Sn)	7440-31-5		0.96	mg
Wire Bond - Au	0.27	mg	Supplier	Gold (Au)	7440-57-5		0.27	mg